503913240 07/13/2016

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KENJI YUM	07/10/2016

RECEIVING PARTY DATA

Name:	BINATONE ELECTRONICS INTERNATIONAL LIMITED	
Street Address:	FLOOR 23A, 9 DES VOEUX ROAD WEST	
City:	SHEUNG WAN	
State/Country:	HONG KONG	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15109797

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ATTORNEY DOCKET NUMBER:	B090-0002US
NAME OF SUBMITTER:	ALEXIS COLLINS
SIGNATURE:	/Alexis Collins/
DATE SIGNED:	07/13/2016

Total Attachments: 2 source=1J75426#page1.tif source=1J75426#page2.tif

PATENT 503913240 REEL: 039147 FRAME: 0128

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial Number
Applicant B090-0002US
Title: DUAL MODE BABY MONITORING
PATENT ASSIGNMENT
PARTIES TO THE ASSIGNMENT
Assignor(s): Kenji Yum Floor 23A, 9 Des Voeux Road West Sheung Wan, Hong Kong CN
Assignee: Binatone Electronics International Limited Floor 23A, 9 Des Voeux Road West Sheung Wan, Hong Kong CN
AGREEMENT
WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of an invention entitled "DUAL MODE BABY MONITORING" for which:
a provisional application for United States Letters Patent was filed on and
was given U.S. Serial Noand/or
a non-provisional application for United States Letters Patent was:
filed on July 5, 2016 and was given U.S. Serial No. 15/109.797 ;
or filed concurrently herewith. Assignors hereby authorize and request ASSIGNEE's legal
representatives, of Lee & Hayes, PLLC, 601 W Riverside Ave, Suite 1400, Spokane, Washington
99201, who are associated with customer number 29150, to insert in the caption above the serial

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number and filing date of the patent application when known.

Attorney Docket No. B090-0002US

WHEREAS, (hereinafter referred to as ASSIGNEE), a corporation of Hong Kong having

a place of business at Floor 23A, 9 Des Voeux Road West, Sheung Wan, Hong Kong, desires to

acquire the entire right, title and interest in and to the invention and in and to any letters patent

that may be granted in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of

which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto ASSIGNEE,

the entire right, title and interest in and to $\,$ said application and any and all letters patent which

may be granted for said invention in the United States of America and its territorial possessions

and in any and all foreign countries, and in any and all divisions, reissues and continuations

thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to

claim priority rights deriving from said United States application to which said foreign

applications are entitled by virtue of international convention, treaty or otherwise, said

invention, application and all letters patent on said invention to be held and enjoyed by

ASSIGNEE and its successors and assigns for their use and benefit and of their successors and

assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S)

had this assignment, transfer and sale not been made. ASSIGNOR(S) hereby authorize and

request the Commissioner of Patents and Trademarks to issue all letters patent on said

invention to ASSIGNEE. ASSIGNOR(S) agree to execute all instruments and documents

required for the making and prosecution of applications for United States and foreign letters

patent on said invention, for litigation regarding said letters patent, or for the purpose of

protecting title to said invention or letters patent. Kenji Yum

10/7/2016

Date

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